IGBT - Field Stop II

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage. Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 10 µs Short Circuit Capability
- This is a Pb–Free Device

Typical Applications

- Solar Inverter
- Uninterruptible Power Supplies (UPS)
- Welding

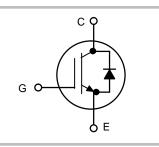
ABSOLUTE MAXIMUM RATINGS Rating Symbol Value Unit Collector-emitter voltage VCES 1200 V Collector current $I_{\rm C}$ А @ Tc = 25°C 60 @ Tc = 100°C 30 Pulsed collector current, Tpulse 120 А I_{CM} limited by T_{Jmax} , 10 µs Pulse, $V_{GE} = 15 \text{ V}$ Diode forward current I_{F} А @ Tc = 25°C 60 @ Tc = 100°C 30 Diode pulsed current, Tpulse limited I_{FM} 120 А by T_{Jmax} Gate-emitter voltage V_{GE} ±20 V Transient gate-emitter voltage ±30 $(T_{pulse} = 5 \mu s, D < 0.10)$ Power Dissipation P_{D} W @ Tc = 25°C 452 @ Tc = 100°C 227 Short Circuit Withstand Time 10 T_{SC} μs $V_{GE} = 15 \text{ V}, \text{ } V_{CE} = 500 \text{ } \text{V}, \text{ } \text{T}_{J} \leq 150^{\circ}\text{C}$ Operating junction temperature ТJ °C -55 to +175 range -55 to +175 °C Storage temperature range T_{stg} 260 °C Lead temperature for soldering, 1/8" T_{SLD} from case for 5 seconds Stresses exceeding those listed in the Maximum Ratings table may damage the

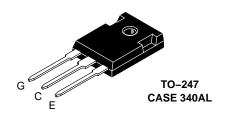


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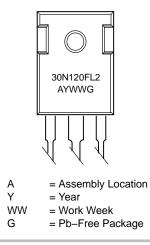
www.onsemi.com

30 A, 1200 V V_{CEsat} = 2.0 V $E_{off} = 0.7 \text{ mJ}$





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB30N120FL2WG	TO–247 (Pb–Free)	30 Units / Rail

device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

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THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ extsf{ heta}JC}$	0.33	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ extsf{ heta}JC}$	0.5	°C/W
Thermal resistance junction-to-ambient	R_{\thetaJA}	40	°C/W

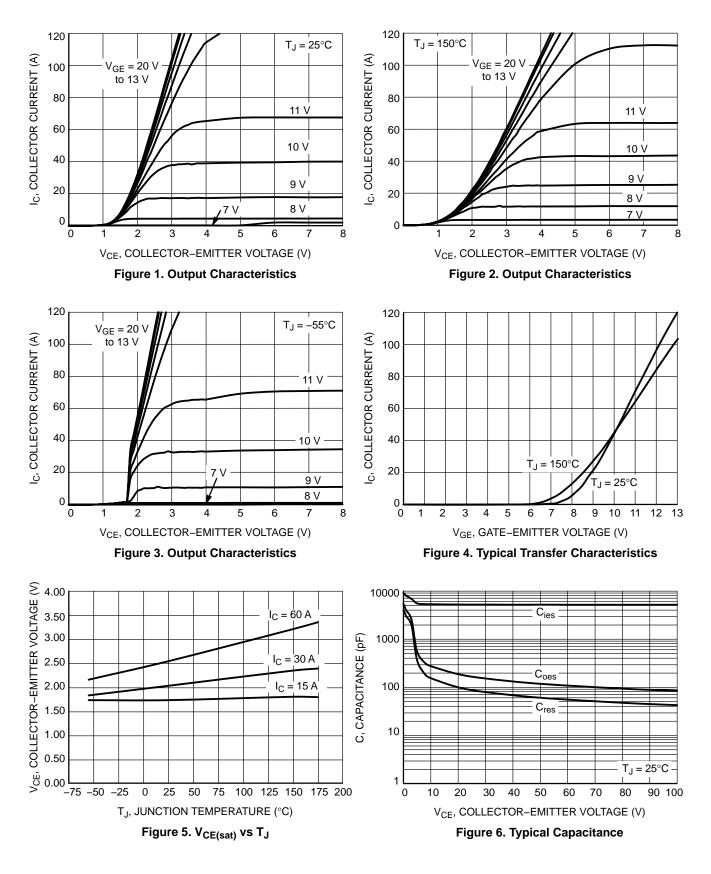
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

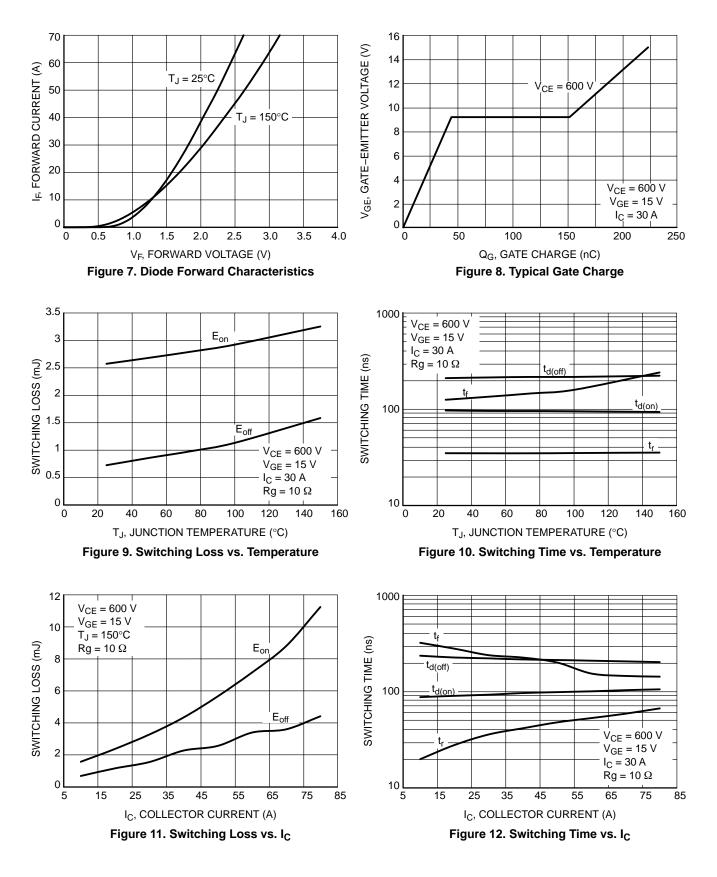
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	1200	-	-	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 30 A V _{GE} = 15 V, I _C = 30 A, T _J = 175°C	V _{CEsat}	-	2.00	2.30 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 400 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V _{GE} = 0 V, V _{CE} = 1200 V V _{GE} = 0 V, V _{CE} = 1200 V, T _J = 175°C	I _{CES}	-	-	1.0 2	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 \text{ V}$, $V_{CE} = 0 \text{ V}$	I _{GES}	-	-	200	nA

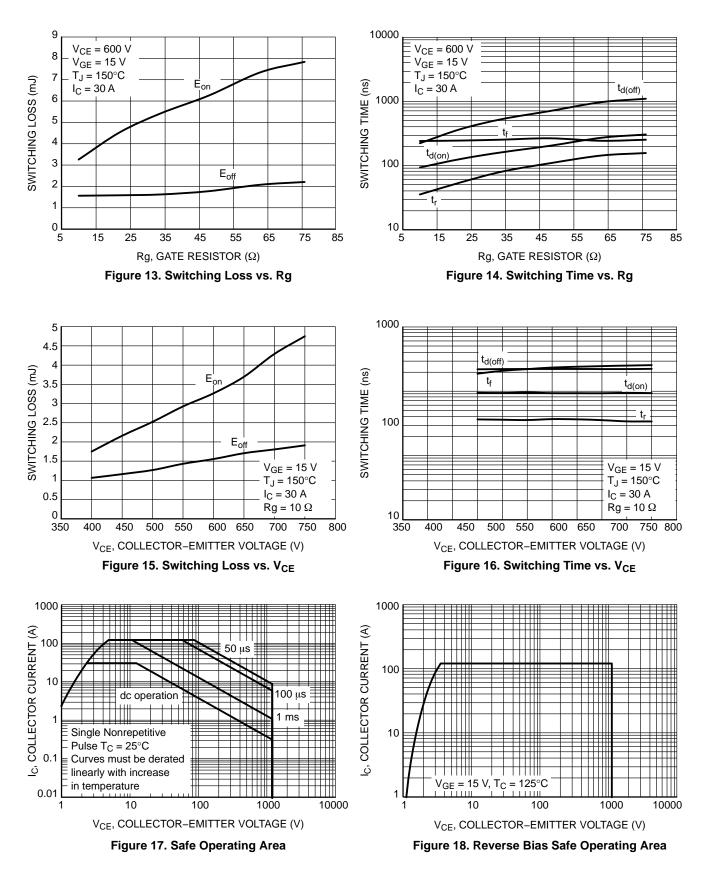
Input capacitance		Cies	-	5250	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	-	170	-	
Reverse transfer capacitance		Cres	-	100	-	
Gate charge total		Qg	-	220	-	nC
Gate to emitter charge	V_{CE} = 600 V, I _C = 30 A, V _{GE} = 15 V	Q _{ge}	-	45	-	
Gate to collector charge		Q _{gc}	-	105	-	

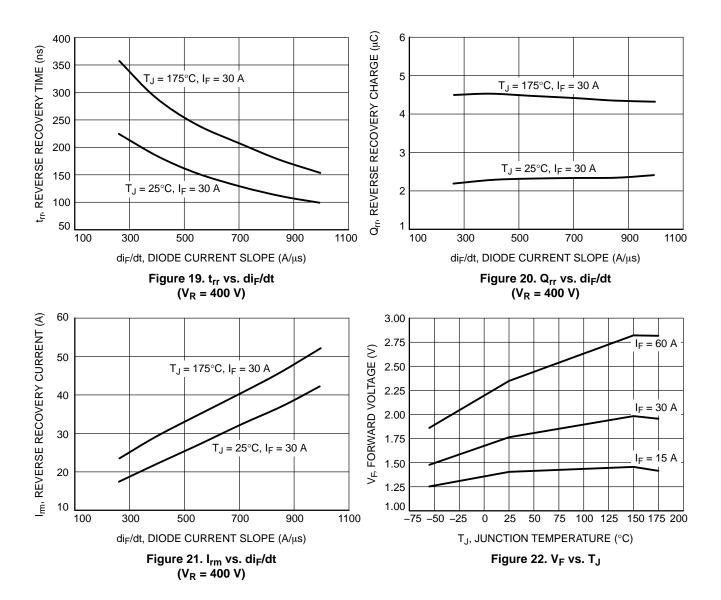
SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

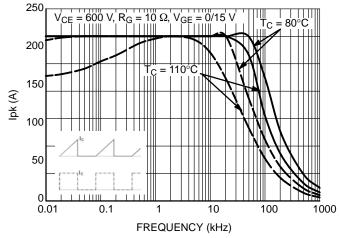
Turn-on delay time		t _{d(on)}	-	98	-	ns
Rise time		t _r	_	35	-	1
Turn-off delay time	T _J = 25°C	t _{d(off)}	_	210	-	1
Fall time	$T_{J} = 25^{\circ}C$ $V_{CC} = 600 \text{ V, } I_{C} = 30 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 0 \text{ V/ } 15 \text{ V}$	t _f	-	130	-	1
Turn-on switching loss	$V_{GE} = 0 V/15V$	Eon	-	2.6	-	mJ
Turn-off switching loss		E _{off}	-	0.7	-	1
Total switching loss		E _{ts}	-	3.3	-	1
Turn-on delay time		t _{d(on)}	-	92	-	ns
Rise time		t _r	-	35	-	1
Turn-off delay time	T _J = 175°C V _{CC} = 600 V, I _C = 30 A	t _{d(off)}	-	220	-	1
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 30 \text{ A}$ $B_{T} = 10 \Omega$	t _f	-	260	-	1
Turn-on switching loss	$R_g = 10 \Omega$ V _{GE} = 0 V/ 15V	Eon	-	3.5	-	mJ
Turn-off switching loss		E _{off}	-	1.8	-	1
Total switching loss		E _{ts}	_	5.3	-	
DIODE CHARACTERISTIC						
Forward voltage	$V_{GE} = 0 \text{ V}, \text{ I}_{F} = 30 \text{ A}$ $V_{GE} = 0 \text{ V}, \text{ I}_{F} = 30 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C}$	V _F	-	1.75 -		V
Reverse recovery time	$T_J = 25^{\circ}C$	t _{rr}	-	240	-	ns
Reverse recovery charge	$I_{F} = 30 \text{ Å}, V_{R} = 400 \text{ V}$	Q _{rr}	_	2.5	-	μC

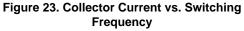


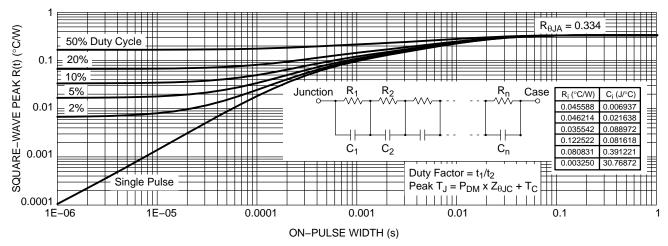


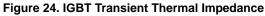












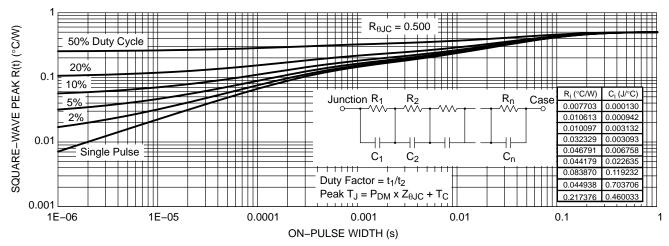
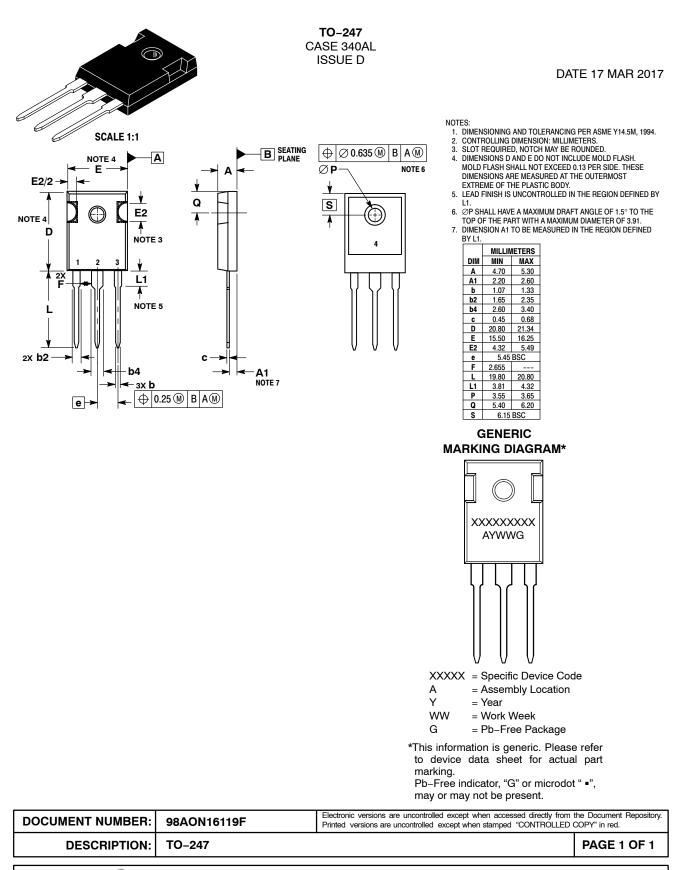


Figure 25. Diode Transient Thermal Impedance

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





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